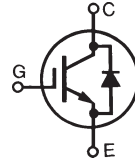


**High Voltage, High Gain  
BIMOSFET™ Monolithic  
Bipolar MOS Transistor**

**IXBH42N170  
IXBT42N170**



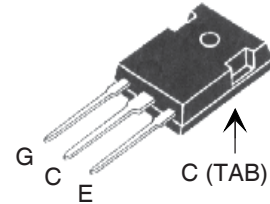
**$V_{CES} = 1700V$**

**$I_{C90} = 42A$**

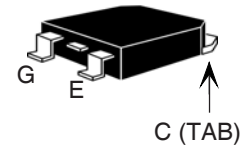
**$V_{CE(sat)} \leq 2.8V$**

Symbol	Test Conditions	Maximum Ratings	
$V_{CES}$	$T_C = 25^\circ C$ to $150^\circ C$	1700	V
$V_{CGR}$	$T_J = 25^\circ C$ to $150^\circ C$ , $R_{GE} = 1M\Omega$	1700	V
$V_{GES}$	Continuous	$\pm 20$	V
$V_{GEM}$	Transient	$\pm 30$	V
$I_{C25}$	$T_C = 25^\circ C$	80	A
$I_{LRMS}$	Terminal Current Limit	75	A
$I_{C90}$	$T_C = 90^\circ C$	42	A
$I_{CM}$	$T_C = 25^\circ C$ , 1ms	300	A
<b>SSOA</b>	$V_{GE} = 15V$ , $T_{VJ} = 125^\circ C$ , $R_G = 10\Omega$	$I_{CM} = 100$	A
<b>(RBSOA)</b>	Clamped inductive load	$V_{CES} \leq 1350$	V
$P_C$	$T_C = 25^\circ C$	360	W
$T_J$		-55 ... +150	$^\circ C$
$T_{JM}$		150	$^\circ C$
$T_{stg}$		-55 ... +150	$^\circ C$
$T_L$	1.6mm (0.062 in.) from case for 10s	300	$^\circ C$
$T_{SOLD}$	Plastic body for 10 seconds	260	$^\circ C$
$M_d$	Mounting torque (TO-247)	1.13/10	Nm/lb.in.
<b>Weight</b>	TO-247	6	g
	TO-268	4	g

**TO-247 (IXBH)**



**TO-268 (IXBT)**



G = Gate      C = Collector  
E = Emitter    TAB = Collector

**Features**

- High blocking voltage
- International standard packages
- Low conduction losses

**Advantages**

- Low gate drive requirement
- High power density

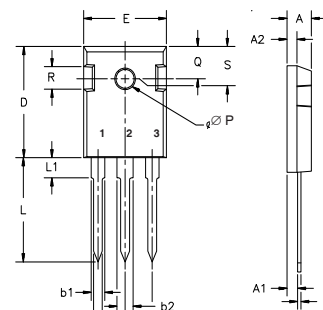
**Applications:**

- Switched-mode and resonant-mode power supplies
- Uninterruptible power supplies (UPS)
- Laser generator
- Capacitor discharge circuit
- AC switches

Symbol	Test Conditions ( $T_J = 25^\circ C$ unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
$BV_{CES}$	$I_C = 250\mu A$ , $V_{GE} = 0V$	1700		V
$V_{GE(th)}$	$I_C = 250\mu A$ , $V_{CE} = V_{GE}$	2.5		5.5 V
$I_{CES}$	$V_{CE} = 0.8 \cdot V_{CES}$ $V_{GE} = 0V$ $T_J = 125^\circ C$			50 $\mu A$ 1.5 mA
$I_{GES}$	$V_{CE} = 0V$ , $V_{GE} = \pm 20V$			$\pm 100$ nA
$V_{CE(sat)}$	$I_C = 42A$ , $V_{GE} = 15V$ , Note 1  $T_J = 125^\circ C$		2.7	2.8 V V

Symbol	Test Conditions	Characteristic Values		
		Min.	Typ.	Max.
$g_{fS}$	$I_C = 42A, V_{CE} = 10V$ , Note 1	24	32	S
$C_{ies}$	$V_{CE} = 25V, V_{GE} = 0V, f = 1MHz$		3990	pF
$C_{oes}$			225	pF
$C_{res}$			70	pF
$Q_g$	$I_C = 42A, V_{GE} = 15V, V_{CE} = 0.5 \cdot V_{CES}$		188	nC
$Q_{ge}$			29	nC
$Q_{gc}$			76	nC
$t_{d(on)}$	<b>Resistive Switching times, <math>T_J = 25^\circ C</math></b> $I_C = 42A, V_{GE} = 15V$ $V_{CE} = 850V, R_G = 10\Omega$		37	ns
$t_r$			139	ns
$t_{d(off)}$			340	ns
$t_f$			665	ns
$t_{d(on)}$	<b>Resistive Switching times, <math>T_J = 125^\circ C</math></b> $I_C = 42A, V_{GE} = 15V$ $V_{CE} = 850V, R_G = 10\Omega$		36	ns
$t_r$			188	ns
$t_{d(off)}$			330	ns
$t_f$			740	ns
$R_{thJC}$			0.35	$^\circ C/W$
$R_{thCS}$	(TO-247)	0.25		$^\circ C/W$

### TO-247 (IXBH) Outline



Terminals: 1 - Gate 2 - Drain  
3 - Source Tab - Drain

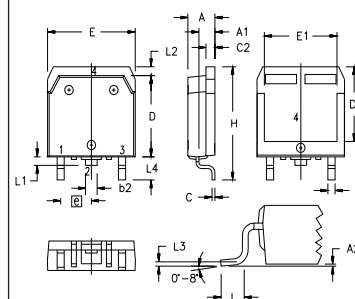
Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.7	5.3	.185	.209
A <sub>1</sub>	2.2	2.54	.087	.102
A <sub>2</sub>	2.2	2.6	.059	.098
b	1.0	1.4	.040	.055
b <sub>1</sub>	1.65	2.13	.065	.084
b <sub>2</sub>	2.87	3.12	.113	.123
C	.4	.8	.016	.031
D	20.80	21.46	.819	.845
E	15.75	16.26	.610	.640
e	5.20	5.72	0.205	0.225
L	19.81	20.32	.780	.800
L <sub>1</sub>		4.50		.177
∅P	3.55	3.65	.140	.144
Q	5.89	6.40	0.232	0.252
R	4.32	5.49	.170	.216
S	6.15	BSC	242	BSC

### Reverse Diode

Symbol	Test Conditions	Characteristic Values		
		Min.	Typ.	Max.
$V_F$	$I_F = 42A, V_{GE} = 0V$			2.8 V
$t_{rr}$	$I_F = 21A, V_{GE} = 0V, -di_F/dt = 100A/\mu s$ $V_R = 100V$		1.32	$\mu s$
$I_{RM}$			36	A

Note 1: Pulse test,  $t \leq 300\mu s$ , duty cycle,  $d \leq 2\%$ .

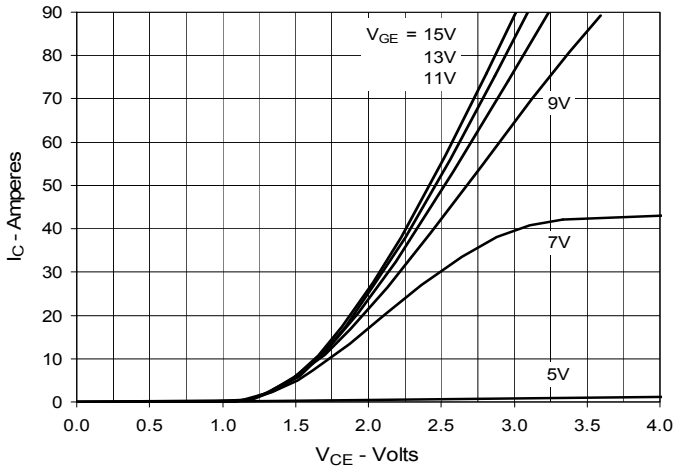
### TO-268 (IXBT) Outline



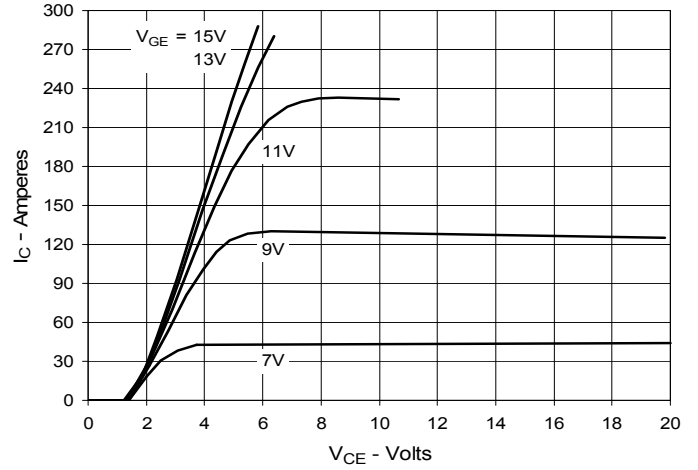
SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.193	.201	4.90	5.10
A1	.106	.114	2.70	2.90
A2	.001	.010	0.02	0.25
b	.045	.057	1.15	1.45
b2	.075	.083	1.90	2.10
C	.016	.026	0.40	0.65
C2	.057	.063	1.45	1.60
D	.543	.551	13.80	14.00
D1	.488	.500	12.40	12.70
E	.624	.632	15.85	16.05
E1	.524	.535	13.30	13.60
e	.215 BSC		5.45 BSC	
H	.736	.752	18.70	19.10
L	.094	.106	2.40	2.70
L1	.047	.055	1.20	1.40
L2	.039	.045	1.00	1.15
L3	.010 BSC		0.25 BSC	
L4	.150	.161	3.80	4.10

IXYS reserves the right to change limits, test conditions and dimensions.

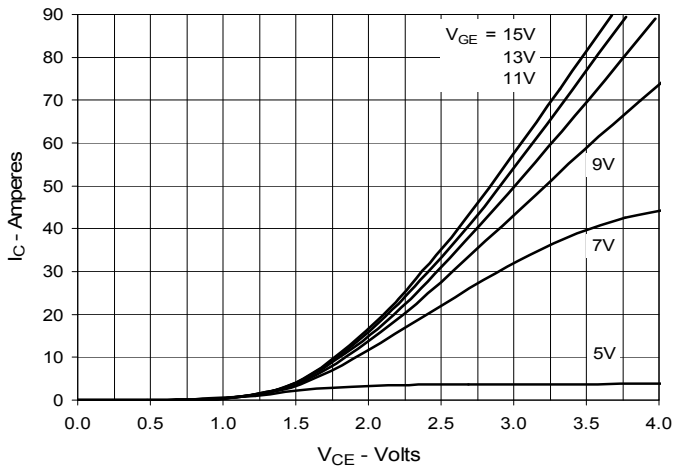
**Fig. 1. Output Characteristics**  
@ 25°C



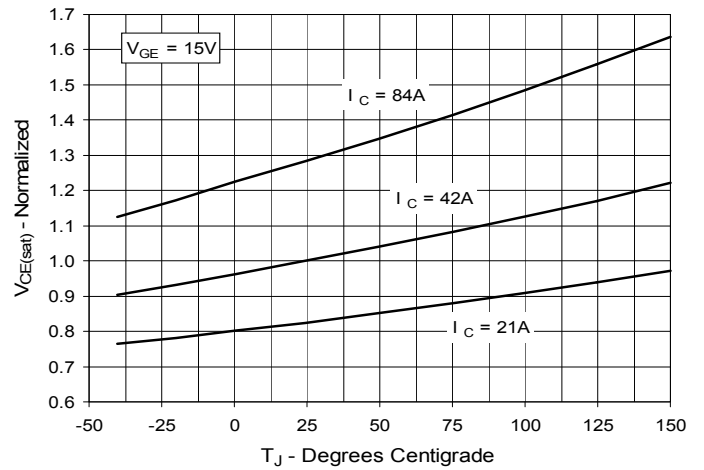
**Fig. 2. Extended Output Characteristics**  
@ 25°C



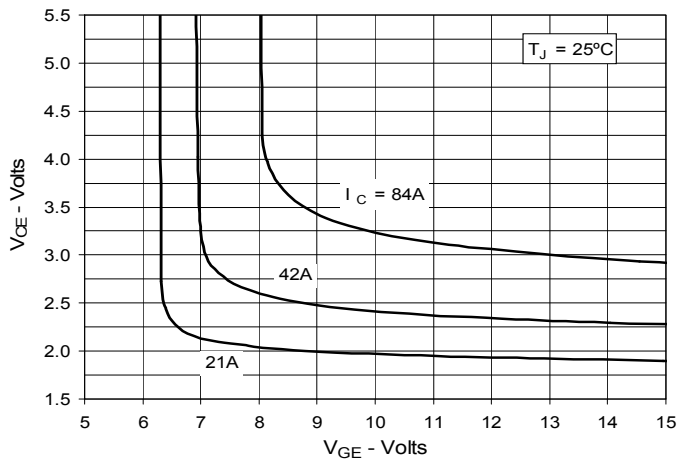
**Fig. 3. Output Characteristics**  
@ 125°C



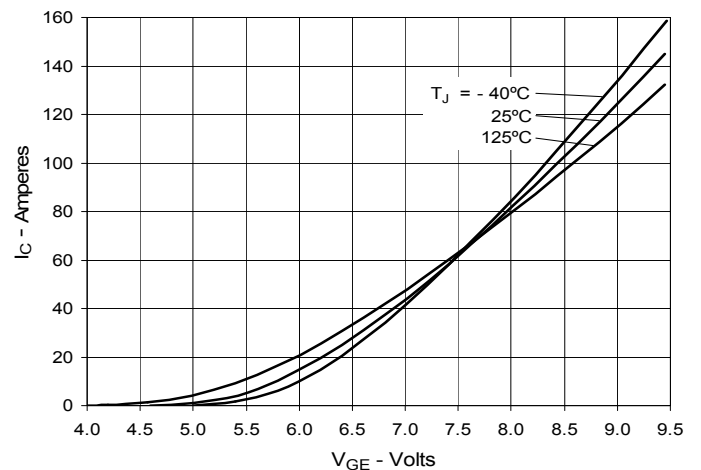
**Fig. 4. Dependence of Vce(sat) on Junction Temperature**



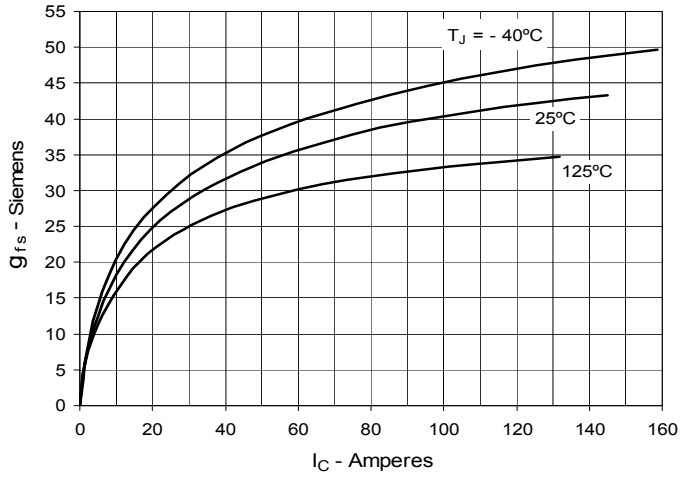
**Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage**



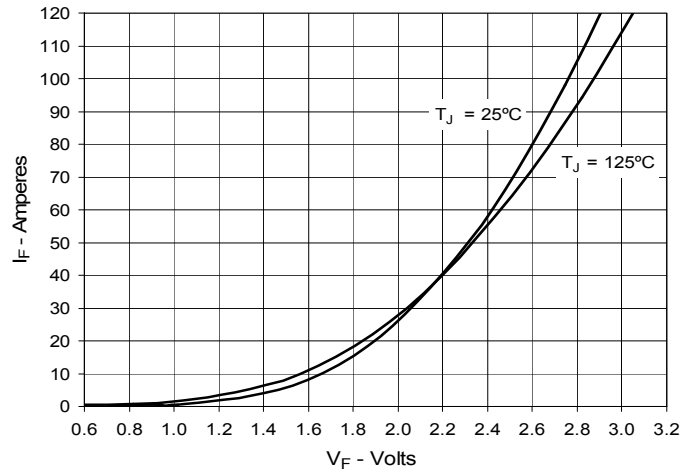
**Fig. 6. Input Admittance**



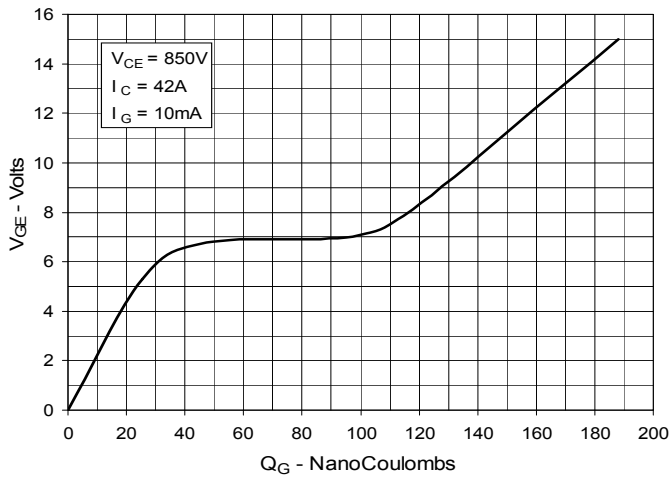
**Fig. 7. Transconductance**



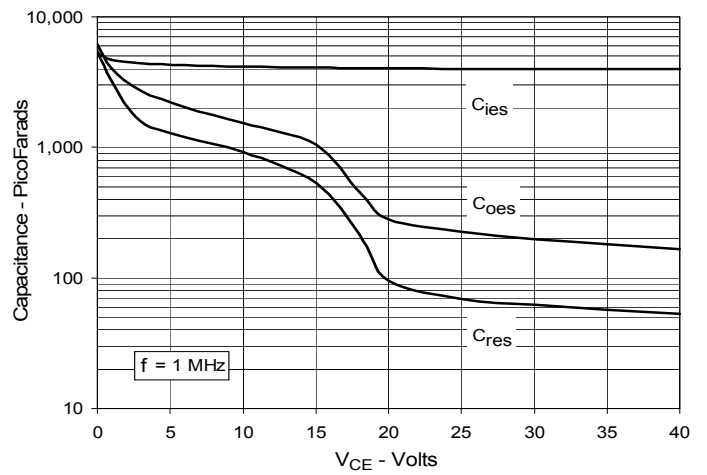
**Fig. 8. Forward Voltage Drop of Intrinsic Diode**



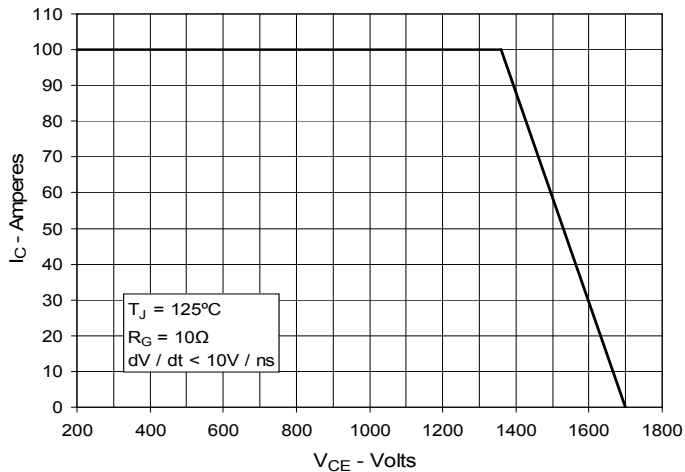
**Fig. 9. Gate Charge**



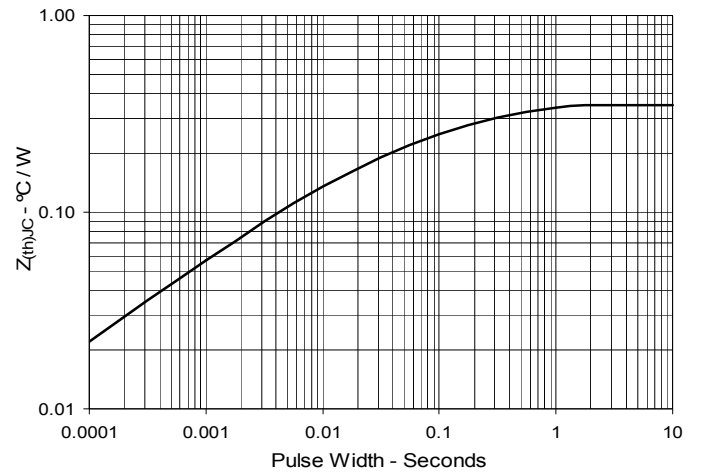
**Fig. 10. Capacitance**



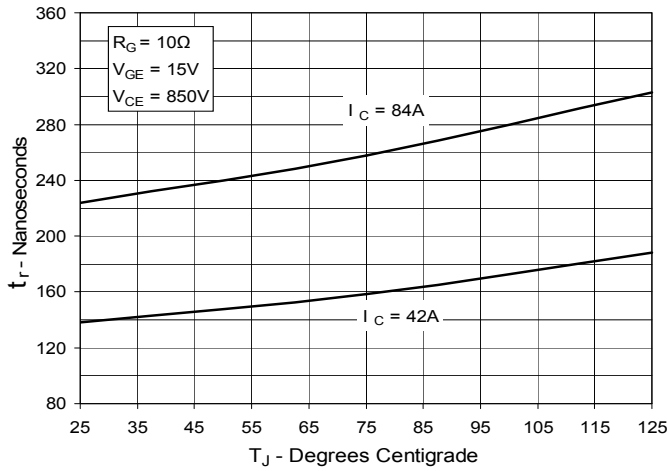
**Fig. 11. Reverse-Bias Safe Operating Area**



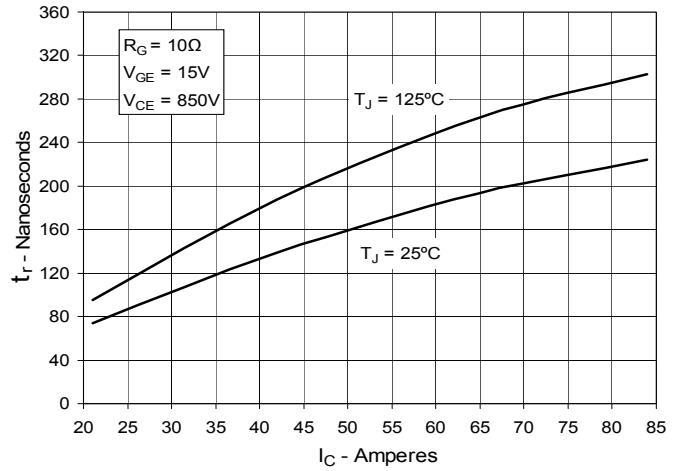
**Fig. 12. Maximum Transient Thermal Impedance**



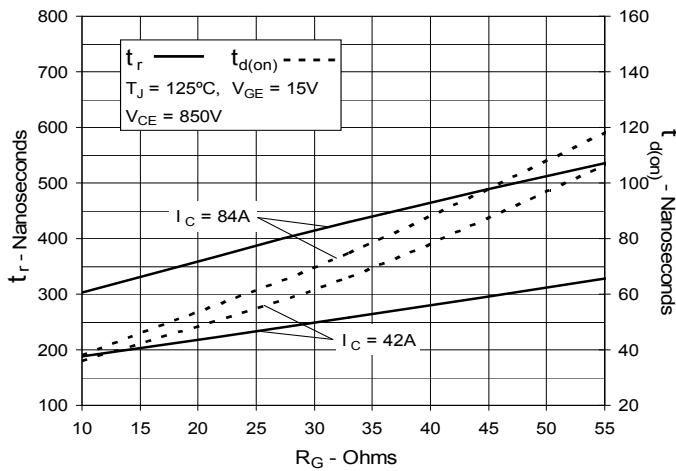
**Fig. 13. Resistive Turn-on  
Rise Time vs. Junction Temperature**



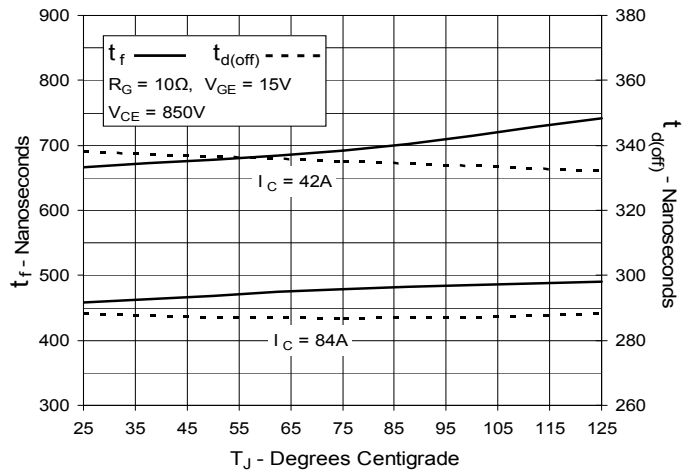
**Fig. 14. Resistive Turn-on  
Rise Time vs. Drain Current**



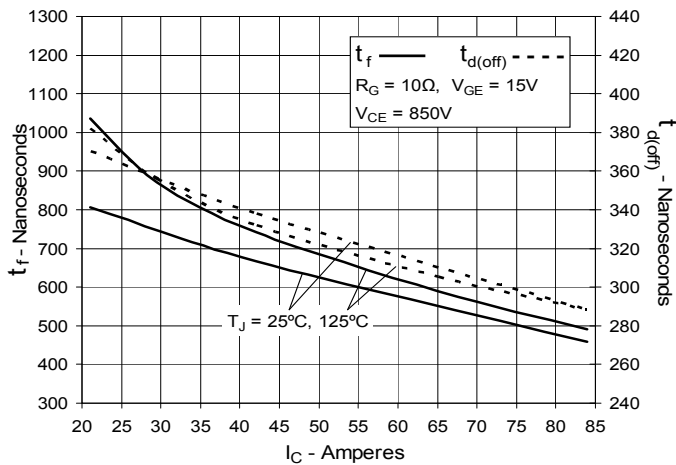
**Fig. 15. Resistive Turn-on  
Switching Times vs. Gate Resistance**



**Fig. 16. Resistive Turn-off  
Switching Times vs. Junction Temperature**



**Fig. 17. Resistive Turn-off  
Switching Times vs. Drain Current**



**Fig. 18. Resistive Turn-off  
Switching Times vs. Gate Resistance**

